onsemi

MARKING DIAGRAMS

TinyLogic UHS Dual 2-Input OR Gate

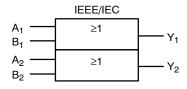
NC7WZ32

Description

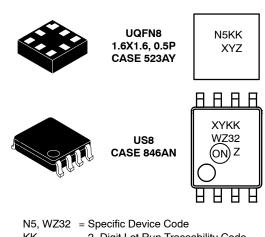
The NC7WZ32 is a dual 2–lnput OR Gate from **onsemi**'s Ultra High Speed Series of TinyLogic. The device is fabricated with advanced CMOS technology to achieve ultra high speed with high output drive while maintaining low static power dissipation over a very broad V_{CC} operating range. The device is specified to operate over the 1.65 V to 5.5 V V_{CC} range. The inputs and output are high impedance when V_{CC} is 0 V. Inputs tolerate voltages up to 6.5 V independent of V_{CC} operating voltage.

Features

- Space Saving US8 Surface Mount Package
- MicroPak[™] Pb-Free Leadless Package
- Ultra High Speed: t_{PD} = 2.4 ns Typ. into 50 pF at 5 V V_{CC}
- High Output Drive: ±24 mA at 3 V V_{CC}
- Broad V_{CC} Operating Range: 1.65 V to 5.5 V
- $\bullet\,$ Matches the Performance of LCX when Operated at 3.3 V V_{CC}
- Power Down High Impedance Inputs / Output
- Overvoltage Tolerant Inputs Facilitate 5 V to 3 V Translation
- Proprietary Noise / EMI Reduction Circuitry Implemented
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant







KK	= 2-Digit Lot Run Traceability Code
XY	= 2-Digit Date Code Format

= Assembly Plant Code

Ζ

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 6 of this data sheet.

Connection Diagrams

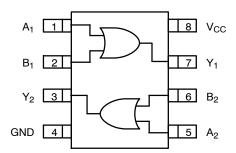
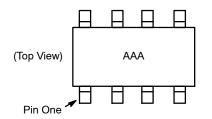


Figure 2. Connection Diagram (Top View)



AAA represents Product Code Top Mark - see ordering code

NOTE: Orientation of Top Mark determines Pin One location. Read the top product code mark left to right, Pin One is the lower left pin (see diagram).

Figure 3. Pin One Orientation Diagram

PIN DESCRIPTIONS

Pin Names	Description
A _n , B _n	Inputs
Y _n	Output

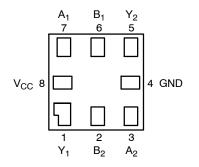


Figure 4. Pad Assignments for MicroPak (Top Thru View)

Inp	Output	
А	В	Y
L	L	L
L	Н	Н
н	L	Н
Н	Н	Н

H = HIGH Logic Level L = LOW Logic Level

ABSOLUTE MAXIMUM RATINGS

Symbol	Paramo	Min	Max	Unit	
V _{CC}	Supply Voltage	Supply Voltage			V
V _{IN}	DC Input Voltage		-0.5	6.5	V
V _{OUT}	DC Output Voltage		-0.5	6.5	V
Ι _{ΙΚ}	DC Input Diode Current	V _{IN} < 0 V	-	-50	mA
I _{OK}	DC Output Diode Current	V _{OUT} < 0 V	-	-50	mA
I _{OUT}	DC Output Current	DC Output Current			mA
I_{CC} / I_{GND}	DC V _{CC} / GND Current		-	±100	mA
T _{STG}	Storage Temperature		-65	+150	°C
TJ	Junction Temperature under Bias	Junction Temperature under Bias			°C
ΤL	Junction Lead Temperature (Soldering, 10 Seconds)		-	260	°C
PD	Power Dissipation in Still Air US8		-	500	mW
		MicroPak-8	-	539	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

Symbol		Parameter	Min	Max	Unit
V _{CC}	Supply Voltage Operating		1.65	5.5	V
	Supply Voltage Data Rete	ntion	1.5	5.5	
V _{IN}	Input Voltage		0	5.5	V
V _{OUT}	Output Voltage		0	V _{CC}	V
T _A	Operating Temperature		-40	+85	°C
t _r , t _f	Input Rise and Fall Time	V_{CC} = 1.80 V ±0.15 V, 2.5 V ±0.2 V	0	20	ns/V
		V _{CC} = 3.3 V ±0.3 V	0	10	
		V _{CC} = 5.0 V ±0.5 V	0	5	1
θ_{JA}	Thermal Resistance	US8	-	250	°C/W
		MicroPak-8	-	232	1

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability. 1. Unused inputs must be held HIGH or LOW. They may not float.

DC ELECTICAL CHARACTERISTICS

					٦	Γ _A = +25°0	C	T _A = -40	to +85°C	
Symbol	Parameter	Co	nditions	V _{CC} (V)	Min	Тур	Мах	Min	Max	Unit
V _{IH}	HIGH Level Input			1.65 to 1.95	0.65 V _{CC}	-	-	0.65 V _{CC}	-	V
	Voltage			2.3 to 5.5	0.7 V _{CC}	-	-	0.7 V _{CC}	-	
V _{IL}	LOW Level Input			1.65 to 1.95	-	-	0.35 V _{CC}	-	0.35 V _{CC}	V
	Voltage			2.3 to 5.5	-	-	0.3 V _{CC}	-	0.3 V _{CC}	
V _{OH}	HIGH Level Output	$V_{IN} = V_{IH}$	I _{OH} = -100 μA	1.65	1.55	1.65	-	1.55	-	V
	Voltage	or V _{IL} ,		2.3	2.2	2.3	-	2.2	-	
				3.0	2.9	3.0	-	2.9	-	
				4.5	4.4	4.5	-	4.4	-	
			I _{OH} = -4 mA	1.65	1.29	1.52	-	1.29	-	
			I _{OH} = -8 mA	2.3	1.9	2.15	-	1.9	-	
			I _{OH} = -16 mA	3.0	2.4	2.80	-	2.4	-	
			I _{OH} = -24 mA	3.0	2.3	2.68	-	2.3	-	
		I _{OH} = -32 mA	4.5	3.8	4.20	-	3.8	-		
V _{OL} LOW Level Output	LOW Level Output	$V_{IN} = V_{IH}$	I _{OL} = 100 μA	1.65	-	0.0	0.1	-	0.1	V
	Voltage	or V _{IL} ,		2.3	-	0.0	0.1	-	0.1	
				3.0	-	0.0	0.1	-	0.1	
				4.5	-	0.0	0.1	-	0.1	
			I _{OL} = 4 mA	1.65	-	0.08	0.24	-	0.24	
			I _{OL} = 8 mA	2.3	-	0.10	0.3	-	0.3	1
		I _{OL} = 24 m	I _{OL} = 16 mA	3.0	-	0.15	0.4	-	0.4	
			I _{OL} = 24 mA	3.0	-	0.22	0.55	-	0.55	
			I _{OL} = 32 mA	4.5	-	0.22	0.55	-	0.55	
I _{IN}	Input Leakage Current	V _{IN} = 5.5	V, GND	1.65 to 5.5	-	-	±0.1	_	±1	μA
I _{OFF}	Power Off Leakage Current	V_{IN} or V_{OUT} = 5.5 V		0.0	-	-	1	_	10	μA
I _{CC}	Quiescent Supply Current	V _{IN} = 5.5 \	/, GND	1.65 to 5.5	-	_	1	-	10	μA

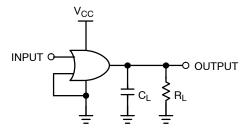
NC7WZ32

AC ELECTRICAL CHARACTERISTICS

				$T_A = +25^{\circ}C$ $T_A = -40 \text{ to } +85^{\circ}C$			to +85°C		
Symbol	Parameter	Conditions	V _{CC} (V)	Min	Тур	Max	Min	Max	Unit
t _{PLH} , t _{PHL}	Propagation Delay	$C_{L} = 15 \text{ pF},$	1.8 ±0.15	-	5.8	10.5	-	11	ns
	(Figure 5, 7)	$R_L = 1 M\Omega$	2.5 ±0.2	-	3.5	5.8	-	6.2	
			3.3 ±0.3	-	2.6	3.9	-	4.3	
			5.0 ±0.5	-	1.8	3.1	-	3.3	
		C _L = 50 pF,	3.3 ±0.3	-	3.2	4.8	-	5.2	
		R _L = 500 Ω	5.0 ±0.5	-	2.4	3.7	-	4.0	
C _{IN}	Input Capacitance		0	-	2.5	-	-	-	pF
	Power Dissipation Capacitance	(Note 2)	3.3	-	14	-	-	-	pF
(Figure 6)			5.0	-	18	-	-	-	

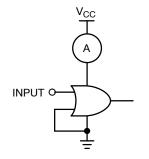
2. C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. (see Figure 6) C_{PD} is related to I_{CCD} dynamic operating current by the expression: I_{CCD} = (C_{PD}) (V_{CC}) (f_{IN}) + (I_{CC}static).

AC Loading and Waveforms



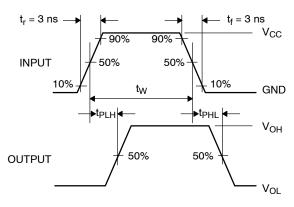
 C_L includes load and stray capacitance Input PRR = 1.0 MHz, t_W = 500 ns

Figure 5. AC Test Circuit



Input = AC Waveforms; $t_r = t_f = 1.8$ ns; PRR = 10 MHz; Duty Cycle = 50%.

Figure 6. I_{CCD} Test Circuit





NC7WZ32

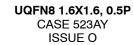
ORDERING INFORMATION

Order Number	Top Mark	Package	Shipping [†]
NC7WZ32K8X	WZ32	8-Lead US8, JEDEC MO-187, Variation CA 3.1 mm Wide	3000 / Tape & Reel
NC7WZ32K8X-L22236	WZ32	8-Lead US8, JEDEC MO-187, Variation CA 3.1 mm Wide	3000 / Tape & Reel
NC7WZ32L8X	N5	8-Lead MicroPak, 1.6 mm Wide (Pb-Free)	5000 / Tape & Reel

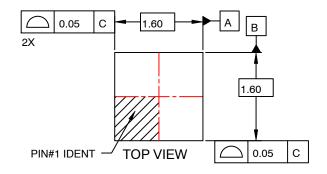
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
3. Pb-Free package per JEDEC J-STD-020B.

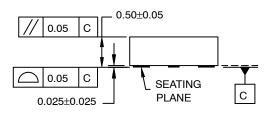
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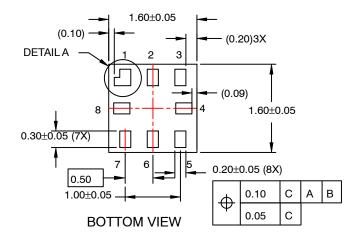


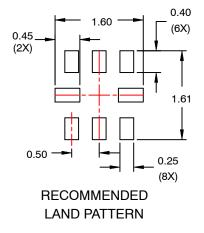
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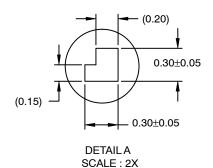
SIDE VIEW





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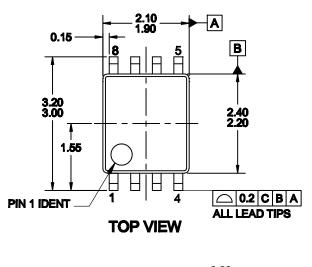
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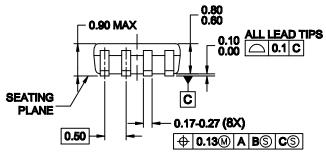
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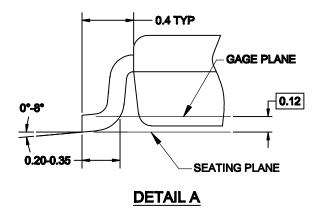
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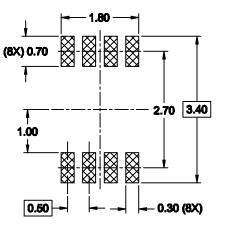
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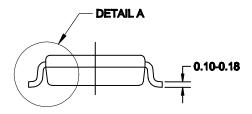




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